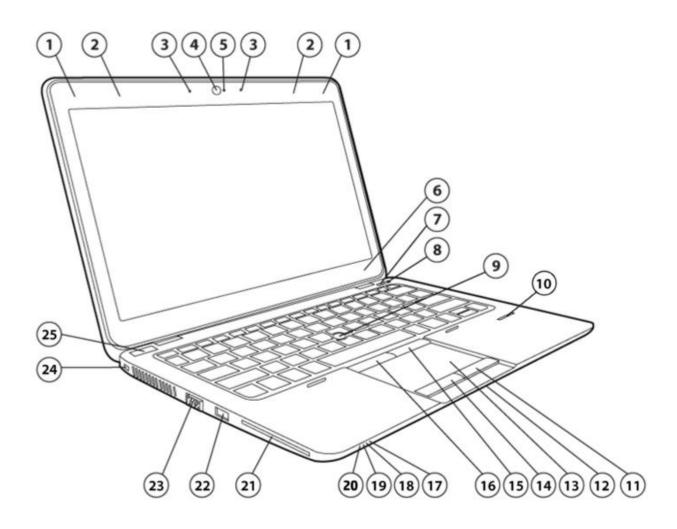
Overview HP EliteBook 850 G2 Notebook PC

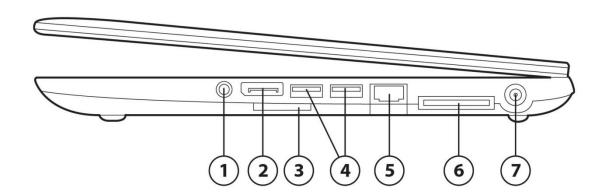


Front/Left

- 1. WLAN antennas (2)
- 2. WWAN antennas (2)
- 3. Internal microphones (2)
- 4. Webcam (select models only)
- 5. Webcam light (select models only)
- 6. Internal display switch
- 7. Wireless button
- 8. Volume mute button
- 9. Pointstick
- 10. Fingerprint reader (optional)
- 11. Right TouchPad button
- 12 NFC sensor (optional)
- 13. TouchPad zone

- 14. Left TouchPad button
- 15. Right pointing stick button
- 16. Left pointing stick button
- 17. Hard drive light
- 18. AC adapter/Battery light
- 19. Power light
- 20. Wireless light
- 21. Smart card reader
- 22. USB 3.0 port
- 23. External VGA monitor port
- 24. Security cable slot
- 25. Power button



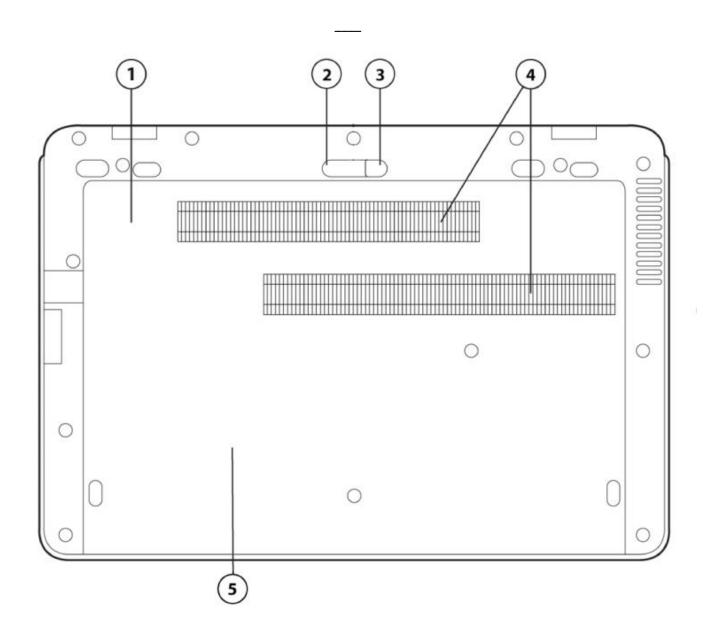


Right

- 1. Audio-out (headphone) jack/Audio-in(microphone) jack
- 2. DisplayPort
- 3. Memory card reader
- 4. USB 3.0 ports (2)

- 5. Drop-jaw Ethernet port (RJ-45)
- 6. Docking port
- 7. Power connector





- 1. EasyAccess panel
- EasyAccess panel release latch
- 3. Security screw

Bottom

- 4. Vents (2)
- 5. SIM slot (inside the panel)*



QuickSpecs

AT A GLANCE

- Windows 8.1, Windows 7, Ubuntu Linux or FreeDOS 2.0
- Magnesium and aluminum chassis, HP DuraFinish, HP DisplaySafe frame, HP duraKeys, precision aluminum drop hinge, aluminum palm rest
- 4-step Soft-touch paint process
- Patent-pending Drop-jaw Ethernet port
- EasyAccess door to quickly access most components for easy serviceability
- Full-sized spill-resistant keyboard; optional back-lit keyboard keeps you productive in low-light settings
- Choice of 5th Generation Intel® Core™ i7 and i5 processors
- Memory options up to 16 GB
- Weight starting at 4.15 lb/1.88 kg
- Storage options up to 1 TB Hard Drives, 512 GB Solid State Drives, or 256GB PCIe Solid State Drive
- M.2 32GB Flash Cache for Intel Smart Response Technology installed in the factory
- M.2 120GB Solid State Drive & 256GB PCIe Solid State Drive can be configured as primary storage or combined with a SATA drive for dual storage performance
- Integrated Intel® HD Graphics 5500 or AMD Radeon™ R7 M260X discrete graphics with 1 GB dedicated GDDR5 video memory
- Choice of Touch or Non Touch 15.6" diagonal displays
- Easily hot dock with the 2013 UltraSlim Docking Station
- DisplayPort for high resolution support
- Touchpad with scroll zone, on/off button with LED indicator
- Enhanced security features including HP Sure Start self-healing BIOS, HP Client Security and optional HP Fingerprint Reader
- Optional HD webcam with dual-microphone array for video conferencing
- HD Audio with DTS Studio Sound™ optimized for high fidelity audio
- Wireless and speaker mute buttons
- Supports a broad range of wireless LAN and wireless WAN options, including 4G LTE, for connectivity on the go.
- UEFI BIOS Compliant with 2.3.1 UEFI Specification

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP ELITEBOOK 850 G2 NOTEBOOK PC

OPERATING SYSTEM

Preinstalled Windows 8.1 Pro 64*

Windows 8.1 64*

Windows 7 Professional 64 (available through downgrade rights from Windows 8.1 Pro 64)**
Windows 7 Professional 32 (available through downgrade rights from Windows 8.1 Pro 64)**

Windows 7 Professional 32* Windows 7 Professional 64*

Ubuntu Linux FreeDOS 2.0

Web-only Support Windows 8.1 Enterprise 64*

Windows 8 Chinese Market 64* Windows 8 Emerging Markets 64* Windows 8 Multi-Language 64* Windows 8 Professionals 64* Windows 7 Enterprise 32* Windows 7 Enterprise 64*

PROCESSOR

5th Generation Intel® Core™ i3-5010U 2.1-GHz 3-MB L3 Cache, 15W

5th Generation Intel® Core™ i5-5200U 2.2-GHz (max turbo frequency 2.7-GHz), 3 MB L3 cache, 15W

5th Generation Intel® Core™ i5-5300U 2.3-GHz (max turbo frequency 2.9-GHz), 3 MB L3 Cache, 15W

5th Generation Intel® Core™ i7-5500U 2.4-GHz (max turbo frequency 3.0-GHz), 4 MB L3 Cache, 15W

5th Generation Intel® Core™ i7-5600U 2.6-GHz (max turbo frequency 3.2-GHz), 4 MB L3 Cache, 15W

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.



^{*} Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows functionality. See http://www.microsoft.com for details.

^{**} This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

^{*} Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

^{**} Not available with Intel iAMT (*Not available with vPro)

INTEL TURBO BOOST TECHNOLOGY*

Intel Turbo Boost is a feature that speeds up the CPU for a short time. It is similar to overclocking the processor, except within a framework provided by Intel. This feature provides additional performance and allows the computer to perform certain tasks more quickly. It also draws additional power and generates additional heat. Therefore, if Turbo Boost is used while powered from battery, it causes additional stress on the battery.

Using Turbo Boost while powered from battery might impact battery cycle life. Cycle life describes how long the battery will last before it needs to be replaced. A cycle refers to one complete charge/discharge cycle of the battery. Because Turbo Boost causes extra stress on the battery, it often shortens the lifetime of the battery.

HP decided not to enable Turbo Boost when powered from battery. This decision was based on the desire to give customers the greatest battery cycle life possible. Turbo Boost is enabled when powered from AC adapter.

Based on customer requests, HP will provide an option to enable Turbo Boost while powered from battery. For the 2013 platform, it will be an F10 option. Turbo Boost will be available for devices powered from battery by the end of the year. The additional performance might cause a slight reduction in battery cycle life, but will not void the battery warranty.

*Implementing Turbo Boost in F10 option is only allowed for batteries over 40WHr. Intel® Turbo Boost technology requires a PC with a processor with Intel Turbo Boost capability. Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

CHIPSET

Chipset integrated with processor

INTEL CORE 15 WITH VPRO/CORE 17 WITH VPRO TECHNOLOGY CAPABLE

Intel Core i5 with vPro and Core i7 with vPro technology is a selectable feature that is available on units configured with select processors, an Intel Centrino® Advanced-N or Ultimate-N WLAN module and a preinstalled Windows operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel Active Management Technology 9.0 (iAMT) offers built-in manageability and proactive security for networked notebook PCs, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update PCs regardless of their power state.
*Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of this technology, such as Intel® Active management technology and Intel Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro technology is dependent on 3rd party software providers. Microsoft Windows required.

GRAPHICS

Integrated:
Intel® HD* Graphics 5500
Discrete
AMD Radeon™ R7 M260X*, with 1 GB dedicated DDR5 video memory**

*HD content required to view HD images.

**AMD Dynamic Switchable Graphics technology requires an Intel processor, plus an AMD Radeon™ discrete graphics configuration and is not available on FreeDOS and Linux OS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete



graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).

DISPLAY

Internal

Non Touch

15.6" diagonal LED-backlit HD anti-glare SVA flat (1366x768)

15.6" diagonal LED-backlit HD anti-glare SVA flat (1366x768) with camera

15.6" diagonal LED-backlit FHD anti-glare SVA Slim (1920x1080)

15.6" diagonal LED-backlit FHD anti-glare SVA Slim (1920x1080) with camera

Touch

15.6" FHD diagonal LED-backlit SVA Slim (1920x1080) with camera

Touch panel has chemically-strengthened Corning® Gorilla® Glass 3 top cover

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 1920 x 1200 external resolution@75 Hz

DisplayPort

Supports resolutions up to 3840 x 2160 @ 60Hz. Supports Multi-Stream Transport (MST) where three displays can be daisy chained with digital displays through DisplayPort Only. The full resolution of each display will be limited as you reach 3 displays due to the bandwidth limitations with a maximum resolution of:

- 2560x1600@60Hz for 2 displays
- 1920x1200@60Hz for 3 displays

Number of Displays supported

3 With Optional 2013 UltraSlim Docking Station Sold separately.

STORAGE AND DRIVES

Primary Storage Bay

Hard Drives*

320 GB 7200rpm SATA Hard Drive 500 GB 7200rpm SATA Hard Drive 500 GB 7200rpm Self-Encrypting Drive 500 GB 5400rpm Self-Encrypting Drive (FIPS-140-2)

1TB 7200rpm SATA Hard Drive

Solid State Drive*

120 GB M.2 Solid State Drive 128 GB SATA-3 Solid State Drive 180 GB SATA-3 Solid State Drive 180 GB SATA-3 Self-Encrypting Drive 240 GB SATA-3 Solid State Drive 256 GB SATA-3 Solid State Drive



256 GB SATA-3 Self-Encrypting Drive 256 GB M.2 PCIe Solid State Drive 512 GB SATA-3 Solid State Drive

HP 3D DriveGuard (Windows only)

HP 3D DriveGuard mitigates the risk of hard drive failures, safeguarding your data when you are on the go by sensing sudden movement and protecting the hard drive. The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive.

*For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 30 GB (for Windows 8) of system disk is reserved for the system recovery software.

FLASH CACHE

32 GB M.2 (NGFF)

Optional 32 GB M.2 flash cache module support for Intel Smart Response Technology. Available only with standard non-SED hard drive.

MEMORY

Standard

DDR3L SDRAM (1600 MHz)

Two SODIMM slots supporting dual-channel memory

4 GB Total System Memory (4 GB x 1)

8 GB Total System Memory (4 GB x 2) (Not available with Windows 7 Professional 32)

8 GB Total System Memory (8 GB x 1)) (Not available with Windows 7 Professional 32)

16 GB Total System Memory (8 GB x 2)) (Not available with Windows 7 Professional 32)

Maximum

Upgradeable to 16 GB with optional 8 GB SODIMMs in slots 1 and 2*

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

* Maximum memory capacities assume Windows 64-bit operating systems or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Broadband Wireless (WWAN) requires a Windows operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth is also available (factory configurable only) and can be combined with any of the supported wireless LAN and wireless WAN options.

Broadband Wireless (WWAN)*

HP lt4112 LTE/HSPA+ Qualcomm® Gobi™ 4G Module HP lt4211 LTE/EV-DO/HSPA+ Qualcomm® Gobi™ 4G Module HP hs3110 HSPA+ Mobile Broadband Module

* WWAN is an optional feature sold separately or as an add on feature. WWAN connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and



availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

** 4G LTE WWAN is an optional feature, not available on all products, in all regions and requires separately purchased service contract. Check with service provider for coverage and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

Wireless LAN (WLAN)*

Intel® Dual Band Wireless-AC 7265 802.11 ac (2X2) Wi-Fi + Bluetooth® Intel® Dual Band Wireless-7265AN 802.11 a/b/g/n (2X2) Wi-Fi + Bluetooth® Intel® Dual Band Wireless-AC 3160 802.11 ac (1x1) Wi-Fi + Bluetooth®

*Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.

Communications

Intel® I218LM Gigabit* Network Connection (10/100/1000 NIC)

* The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Optional Near Field Communication (NFC)

AUDIO/MULTIMEDIA

Audio

HD Audio with DTS Studio Sound™
2 Integrated stereo speakers
Integrated dual-microphone array; located in the display
Function keys for microphone mute, volume up, volume down
Stereo headphone/line out
Stereo microphone/line in

Webcam

Optional* 720p HD** webcam

- HD format (widescreen)
- Supports videoconferencing (non-HD) and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range
- Skype-ready ***

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and includes an all-metal keyboard deck for greater rigidity, as well as HP DuraKeys. The 101/102-key compatible keyboard features a full-pitch key



^{*}Sold separately or as an optional feature.

^{**} HD content required to view HD images.

^{***}Internet access required.

layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. US and International key layouts are available. Backlit keyboard available as an option.

Pointing Devices

Touchpad with scroll zone, on/off button with LED indicator, two-way scroll, two pick buttons

Buttons and Function Keys

Separate discrete buttons provide easy access to WLAN on/off and speaker mute. Function keys provide control of features including: standby mode, display brightness, external display, microphone mute, volume down, and volume up.

* In independent testing conducted by Trace Laboratories, HP DuraKeys showed no wear after 250,000 cycles. Competitor notebooks showed significant wear after only 5,000 cycles.)

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System

BIOS

HP BIOSphere*
HP Sure Start
HP DriveLock | HP

HP DriveLock | HP Automatic Drive Lock

HP BIOS Protection***
HP Disk Sanitizer ****

HP SpareKey*****

Update via Network

Master Record Security

Power On Authentication

Pre-Boot Security

Secure Erase*****

Hybrid Boot

Measured Boot

Secure Boot

Absolute Persistence Module******

- * Available only on business PCs with HP BIOS.
- *** May require a manual recovery step if all copies of BIOS are compromised or deleted.
- **** For the use cases outlined in the DOD 5220.22-M Supplement. Does not support solid state drives.
- ***** Requires initial user set up.

******* For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.

******* Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription.

Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

MultiMedia

CyberLink PowerDVD CyberLink YouCam BE

Communication

HP Connection Manager (Windows 7 only)



HP GPS and Location*
HP Mobile Connect (Windows 8 only)**
HP Wireless Hotspot*** (Windows 8 only)
Intel WiDi Software****
Intel My WiFi and Wireless Drivers

HP Value Add Software

Getting Started with Windows 8
HP 3D DriveGuard (Windows required)
HP ePrint Driver (HP Exclusive)****
HP Hotkey Support
HP PageLift
HP Recovery Manager (Windows 7 only)
HP Support Assistant
HP Recovery Disc Creator (Windows 7 only)
UEFI System Diagnostics W8

3rd Party

Adobe® Flash Player (Commercial) Foxit PhantomPDF Express for HP Bing Search Skype****** Buy Office

NOTE: HP Recovery Manager enables fast recovery of the factory preinstalled image if the system becomes corrupted or if important system files are accidentally deleted. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8) of system disk is reserved for the system recovery software.

*GPS access requires an unobstructed path to multiple satellites. Performance may be affected if/when used inside of buildings, bridges or heavily congested metropolitan areas. Requires separately purchased GPS navigation software available from multiple GPS applications.

** HP Mobile Connect is only available on selective devices with wwan. For geographical availability refer to www.hp.com/go/mobileconnect

***The wireless hotspot application requires an active internet connection that is shared with the connecting devices. Wireless hotspot data usage may incur additional charges. Check with your service provider for plan details.

**** Integrated Intel Wi-Di feature is available on select configurations only and requires separately purchased projector, tv or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, tv or computer monitor via a standard HDMI cable, also sold separately.

*****Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/businessmobileprinting. ****** Skype is not offered in China.

Manageability

HP Driver Packs *
HP SoftPaq Download Manager (SDM)*
HP System Software Manager (SSM)*
HP BIOS Config Utility (BCU) *
HP Client Catalog / HP CIK for Microsoft SCCM *
LANDESK Management *

* Not preinstalled

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.



QuickSpecs

Standard Security Features

HP Client Security with Credential Manager and Password Manager (Windows only)

HP Device Access Manager with Just in Time Authentication

HP Drive Encryption (FIPS 140-2 certified)*

HP File Sanitizer**

Microsoft Security Essentials (Windows 7 only)***

Central Management of Client Security Credential Manager with DigitalPersona Pro Workgroup*****

Computrace Support

Security Hardware

TPM 2.0 Security lock slot Fingerprint Reader Integrated Smart Card Reader

NOTE: The Absolute Persistence agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

- * Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.
- ** For the use cases outlined in the DOD 5220.22-M Supplement. Supports standard Hard Drives. Initial setup required.
- *** Opt in and internet connection required for updates.
- ****** In order to deploy and receive updated policies, the client needs to be connected to the network server and requires separately purchased DigitalPersona Pro software. System access may not prevent users from logging into the system on the first attempt if policy updates haven't yet been received and applied. Not all features are remotely manageable.

 ******** Intel Anti-Theft security is supported on Intel Core i processors and requires a separately purchased Absolute Computrace service subscription and must be activated and configured. Check with Absolute for availability in your country. Intel and HP assume no liability for lost or stolen data and/or systems or any other damages resulting therefrom. See http://www.intel.com/technology/anti-theft/.

******** Intel Identity Protection feature is only available with Intel Core Processors. Intel® IPT security requires separate Symantec VIP software service subscription and must be activated and configured. Requires a website that uses Symantec VIP Authentication Service and Microsoft® Windows. Intel® and HP assume no liability for lost or stolen data and/or systems or any other damages resulting therefrom.

For more information on HP security solutions refer to: http://www.hp.com/go/protecttools.

POWER

Power Supply

HP 45W Smart AC Adapter 45W 2-prong 7.4mm DC jack AC Adapter (Only for Japan) HP 65W Smart AC Adapter HP 65W Smart EM AC Adapter (China and India only) Power cord is configurable; either 3.2 feet or 6 feet (1.0 or 1.8 meter)

Total length including external AC adapter is 9.2 feet or 12 feet (2.86 or 3.66 meter).

Primary Battery

3-cell HP Long Life Polymer 24 WHr 3-cell HP Long Life Polymer 50 WHr

Battery Life*



TBD

System Standby Time**

TBD

Power Conservation

Supports enhanced Intel SpeedStep technology (allows Battery Optimized Mode, Maximum Performance Mode, or Automatic mode)

AMD PowerPlay technology (discrete models)

Hibernation

Standby

ACPI compliance

WEIGHTS & DIMENSIONS

Weight

Non Touch

Starting at 4.02 lb/1.83 kg

Weight will vary by configuration.

3-cell (24Whr) battery, HD panel, UMA, no FPR, one SODIMM, WLAN, lightest M.2 SSD primary storage module, no camera, no WWAN

Touch

Starting at 4.02 lb/1.83 kg

Weight will vary by configuration.

3-cell (24Whr) battery, FHD Touch panel, UMA, no FPR, one SODIMM, WLAN, lightest M.2 SSD primary storage module, no camera, no WWAN

Dimensions (w x d x h)

Non Touch

14.78 x 9.98 x 0.84 in (at front) 37.55 x 25.36 x 2.14 cm (at front)

Touch

14.78 x 9.98 x 1.02 in (at front) 37.55 x 25.36 x 2.58 cm (at front)

PORTS/SLOTS

Ports

- (1) DisplayPort 1.2
- (1) USB 3.0 Charging Port
- (3) USB 3.0 Port
- (1) RJ-45 / Ethernet
- (1) Side Docking connector
- (1) Secondary battery connector
- (1) Headphone/Microphone Combo
- (1) AC Port

Expansion Slots

Media Card Reader Supports SD, SDHC, SDXC



SERVICE AND SUPPORT

HP Services offers 3-year, 1-year and 90 day limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties.* To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp

*HP Care Packs are sold separately. Service levels and response times for HP Care Services may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp



SYSTEM UNIT

Stand-Alone Power	Nominal Operating Voltage	19.5 V			
Requirements (AC Power)	Average Operating Power	Windows 7 (64-bit)	Windows8.1 (64-bit)		
	Integrated graphics	4.75 W	4.26 W		
	Max Operating Power	Discrete < 90W			
_	_	UMA < 65W			
Temperature	Operating	32° to 95° F (0° to 35° C) (not writing optical)			
		41° to 95° F (5° to 35° C) (writing optical)			
	Non-operating	-4° to 140° F (-20° to 60° C)			
Relative Humidity	Operating	10% to 90%, non-condensing			
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature			
Shock	Operating	40 G, 2 ms, half-sine			
SHOCK	Non-operating	200 G, 2 ms, half-sine			
Random Vibration					
Kandom vibration	Non-operating	1.50 grms			
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048	3 m)		
Attitude (dilpressurized)	Non-operating	-50 to 40,000 ft (-15.24 to 3,046 m)			
Planned Industry Standard	UL UL	Yes)		
Certifications	CSA	Yes			
cer enreacions	FCC Compliance	Yes			
	ENERGY STAR®	Select models* Registered Gold in United States**			
	EPEAT®				
	ICES	Yes			
	Australia /	Yes			
	NZ A-Tick Compliance				
	CCC	Yes			
	Japan VCCI Compliance	Yes			
	KC	Yes			
	BSMI	Yes			
	CE Marking Compliance	Yes			
BNCI or BELUS Yes					
	CIT	Yes Yes			
	GOST				
	Saudi Arabian Compliance (ICCP)	Yes			
	SABS	Yes			
	UKRSERTCOMPUTER	Yes			

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

DISPLAYS

15.6" diagonal LED- Outline Dimensions $14.17 \times 8.83 \times 0.15 \text{ in } (36.0 \times 22.43 \times 0.38 \text{ cm})$ backlit HD anti-glare SVA $(W \times H \times D)$

flat (1366 x 768) Active Area 13.55 x 7.62 in (34.42 x 19.35 cm)

Weight < 1.1 lb (500 g) (max)



Diagonal Size 15.6 in (39.62 cm)

Surface TreatmentAnti-glareContrast Ratio300:1 (min)Refresh Rate60 Hz

Brightness 200 nit (typical)

Format 1366 x 768 (HD)

Configuration RGB Stripe

Interface eDP 1.2 (1 lane)

LCD Mode TN
PPI 101 ppi

Viewing Angle SVA 30/30/20/10 (min) (Left/Right/Down/Up)

15.6" diagonal LEDbacklit FHD anti-glare SVA flat (1920 x 1080) **Outline Dimensions** 14.17 x 8.83 x 0.15 in (36.0 x 22.43 x 0.32 cm)

 $(W \times H \times D)$

 $(W \times H \times D)$

Active Area 13.55 x 7.62 in (34.42 x 19.36 cm)

 Weight
 < 0.84 lb (380 g) (max)</td>

 Diagonal Size
 15.6 in (39.62 cm)

Surface Treatment Anti-glare **Contrast Ratio** 300:1 (typical)

Refresh Rate 60 Hz

Brightness 300 nit (typical)

Pixel Resolution Format 1920 x 1080 (FHD)

Configuration RGB Stripe

Interface eDP 1.2 (2 lane)

LCD Mode TN PPI 142 ppi

Viewing Angle SVA 30/30/20/10 (min) (Left/Right/Down/Up)

15.6" diagonal LEDbacklit FHD anti-glare SVA flat (1920 x 1080) + touch **Outline Dimensions** 14.17 x 8.83 x 0.15 in (36.0 x 22.43 x 0.32 cm)

Active Area 13.55 x 7.62 in (34.42 x 19.36 cm)

Weight < 0.84 lb (380 g) (max) **Diagonal Size** 15.6 in (39.62 cm)

Touch enabled Yes

TSP Type Capacitive

Touch point supported Min 5-point & Max 10-point for Win8

Surface Treatment Anti-glare **Contrast Ratio** 400:1 (typical)

Refresh Rate 60 Hz

Brightness 300 nit (typical)



Format 1920 x 1080 (FHD)

Configuration RGB Stripe

Interface eDP 1.2 (2 lane)

LCD Mode TN PPI 142 ppi

Viewing Angle SVA 45/45/25/35 (Left/Right/Down/Up)

STORAGE AND DRIVES

320 GB* 7200 rpm SATA Hard Drive **Drive Weight** 0.21 lbs (95 g) **Capacity** 320 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track1.5 ms-2ms(typical reads, including settling)Average12 ms-13msMaximum18ms-22 ms

CacheUp to 32 MBRotational Speed7200 rpmLogical Blocks625,142,448

Operating Temperature 32° to 140° F (0° to 60° C) [case temp] **Features** ATA Security; S.M.A.R.T. IV, NCQ, Ultra DMA

500 GB* 7200 rpm SATA Hard Drive **Drive Weight** 0.20lbs(92g- 0.21 lbs (95g)

Capacity 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek TimeSingle Track1.5 ms-2ms(typical reads, including settling)Average12 ms-13msMaximum18ms-22 ms

Rotational Speed 7200 rpm Logical Blocks 976,773,168

Operating Temperature32° to 140° F (0° to 60° C) [case temp]FeaturesATA Security; S.M.A.R.T.IV, NCQ, Ultra DMA



500 GB* 5400 rpm SMART SATA II FIPS Self Encrypting Drive **Drive Weight** 0.21 lbs (95g) **Capacity** 500 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous (maximum) 600 MB/s (Drive Capability)

Seek Time
(typical reads, including
settling)Single Track
Average1.5 ms
12 msMaximum22 ms

Cache32 MBRotational Speed5400 rpmLogical Blocks976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [case temp]

Features ATA Security; TCG Opal 2.x, FIPS

1 TB* 7200 rpm SATA Hard Drive **Drive Weight** 0.25 lb (115 g)

Capacity 1 TB

 Height
 0.37 in (9.5 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate Synchronous 600 MB/s (Drive Capability)

(maximum)

Seek TimeSingle Track2 ms(typical reads, including settling)Average13 msMaximum15 ms

Rotational Speed 7200 rpm **Logical Blocks** 1,953,525,168

Operating 32° to 140° F (0° to 60° C) [case temp]

Temperature

Features ATA Security; S.M.A.R.T. IV, NCQ, Ultra DMA

SATA 3 Gb/s 32 GB*, M.2 2242 Solid State Drive **Drive Weight** 10 Grams

Capacity 32 GB

 Height
 0.09 in (3.7 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 380 MB/s Up to 110 MB/s

Logical Blocks 62,533,296



Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 120 GB*, M.2 Drive Weight 10 Grams 2242 Solid State Drive Capacity 120 GB

> Height 0.09 in (3.7 mm) Width 0.87 in (22 mm) Interface ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

> Up to 540 MB/s Up to 480 MB/s

Logical Blocks 234,441,648

32° to 158°F (0° to 70°C) [ambient temp] Operating Temperature

Features ATA Security; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 128 GB*, 2.5- Drive Weight inch MLC Solid State

Drive

78 Grams Capacity 128 GB

Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

> Up to 550 MB/s Up to 350 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 128 GB*, 2.5- Drive Weight 78 Grams

inch TLC Solid State Drive

128 GB Capacity

Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface ATA-8. SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

> Up to 520 MB/s Up to 140 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

inch SATA Solid State

Drive

SATA 3 Gb/s 180 GB*, 2.5- Drive Weight 78 Grams Capacity 180 GB

> Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface ATA-8, SATA 3.0



Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s Up to 490 MB/s

Logical Blocks 351,651,888

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 180 GB*, 2.5- Drive Weight Up to 78 Grams

inch SATA SED Solid State

Drive

Capacity 180 GB

Height 0.28 in (7 mm)

Width 2.75 in (69.85 mm)

Interface ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 540 MB/s Up to 490 MB/s

Logical Blocks 351,651,888

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP; TCG Opal 1x

SATA 3 Gb/s 240 GB*, 2.5- Drive Weight 78 Grams inch Solid State Drive Capacity 240 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Logical Blocks 468,862,128

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 256 GB*, 2.5- Drive Weight 78 Grams

inch Solid State Drive

 Capacity
 256 GB

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA8, SATA 3.0



Performance Maximum **Sequential Maximum Sequential Write**

Read

Up to 520 MB/s Up to 280 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TCG Opal 2.x; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 256 GB*, 2.5- Drive Weight inch Self Encrypting Solid Capacity

State Drive

78 Grams 256 GB

Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface ATA8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 550 MB/s Up to 500 MB/s

Logical Blocks 500,118,192

32° to 158°F (0° to 70°C) [ambient temp] Operating Temperature

Features ATA Security; TCG Opal 2.x; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 256 GB*, 2.5- Drive Weight 10 Grams inch M2 PCIe Solid State Capacity 256 GB

Drive

0.24 in (60 mm) Height Width 0.87 in (22 mm) Interface ATA-8. PCIe 2.0

Performance Maximum **Sequential Maximum Sequential Write**

Read

Up to 730 MB/s 620 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; DIPM; TRIM; DEVSLP

SATA 3 Gb/s 512 GB*, 2.5- Drive Weight 78 Grams inch Solid State Drive Capacity 512 GB

> Height 0.28 in (7 mm) Width 2.75 in (69.85 mm)



Interface ATA-8, SATA 3.0

Performance Maximum Sequential Maximum Sequential Write

Read

Up to 550 MB/s Up to 550 MB/s

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp] **Features** ATA Security; DIPM; TRIM; DEVSLP

NETWORKING/COMMUNICATIONS

Broadband Wireless (WWAN)*

HP lt4211 LTE/EV-DO/ HSPA+ Gobi 4G Module

Technology/Operating

bands

LTE: 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 700 (Band 13 upper SMH), 700 (Band 17

lower SMH), 1900 MHz (Band 25, extended PCS) MHz

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz

EV-DO: 800 (BC0), 1900 (BC1) MHz

Wireless protocol

standards

3GPP Release 8 LTE Specification

WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

EVDO Release O and Release A

GPS Standalone, A-GPS

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 100 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

CDMA 1x: DL 153.6 kbps/UL 153.6 kbps EVDO Rev.A: DL 3.1 Mbps/UL 1.8 Mbps

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

E-GPRS 1900/1800: 26.5 dBM E-GPRS 900/850: 27.5 dBM GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm CDMA/EVDO: 24dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,800 mA (peak); 700 mA (average)

EVD0: 1000mA (peak); 720mA (average)



Form Factor M.2, 3042-S3 Kev B

Weight 6 q

Dimensions 1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

(Length x Width x Thickness)

HP lt4112 LTE/HSPA+ Gobi 4G Module**

Technology/Operating

bands

LTE FDD all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz (Band V), 2600 MHz (Band VII), 900

MHz (Band VIII), 800 MHz (Band XX, DD800)

WCDMA/HSDPA/HSUPA/HSPA+ all bands with diversity: 2100 MHz (Band I), 1900 MHz (Band II), 800 MHz (Band V), 900 MHz (Band VIII) GSM/GPRS/EDGE: 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz

(Band V), 900 MHz (Band VIII)

Wireless protocol

Maximum data rates

standards

3GPP Release 8 LTE Specification

WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification Complies with 3GPP specifications Release 8 for LTE

Wireless parametric

standards

LTE (Category 3): 100 Mbps (Download), 50Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

GPS Standalone

GPS bands 1575.42 MHz (± 1.023 MHz), GLONASS 1596-1607MHz

Maximum output power LTE: +23 dBm (+/- 2 dBm)

WCDMA: +23.5 dBm (+/- 1 dBm)

GPRS Band II, III: +29.5 dBm (+/- 1 dBm) GPRS Band V. VIII: +32.5 dBm (+/- 1 dBm) EGPRS Band II, III: +26.5 dBM (+/-1.5 dBm) EGPRS Band V, VIII: +27.5 dBM (+/-1.5 dBm) LTE: 1,200 mA (peak); <900 mA (average)

Maximum power consumption

WCDMA: 1,100 mA (peak); <800 mA (average) EGPRS: 2,800 mA (peak); <700 mA (average)

Power consumption,

sleep mode

3 mA

Power management

USB selective suspend, Integrated notebook wireless button Antenna type Dual high efficiency multi-band antennae with spatial diversity

Form Factor M.2, USB 2.0 interface

Weight 6 g

Dimensions 42 mm × 30 mm × 2.3 mm

(Length x Width x

Thickness)

Voltage, Operating 3.135 V to 4.4 V (3.3 V +1.1V/-0.165V)

Temperature, operating

14° to 131° F (-10° to 55° C)

(from TIA/EIA/IS-98-D)



Temperature, non- -40° to 185° F (-40° to 85° C)

operating, 96 hours (from MIL-STD 202 Method 108)

Humidity, non-operating 95% relative humidity for 48 hours @ 185° F (85° C) (non-condensing)

LED activity LED Off - Radio Off; Solid LED On - Radio On

* 4G LTE not available on all products, in all regions and only available on products featuring Intel processors. WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location,

environment, network conditions, and other factors.

HP hs3110 HSPA+ Mobile Broadband Module

Technology/Operating

bands

HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 700 (Band 17) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz

Wireless protocol

WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

standards

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

GPS Standalone, A-GPS

GPS bands

1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)

Maximum data rates

HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps (Download), 85.6 kbps (Upload)

Maximum output power

HSPA+: 23.5 dBm

E-GPRS 1900/1800: 26.5 dBM E-GPRS 900/850: 27.5 dBM GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm

Maximum power consumption

HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,800 mA (peak); 700 mA (average)

Form Factor

M.2, 3042-S3 Key B

Weight

60

Dimensions

1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

(Length x Width x Thickness)

Wireless LAN (WLAN)

Intel® 802.11 a/b/g/n ac (2X2) + Bluetooth®

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac



Interoperability Frequency Band Wi-Fi certified 802.11b/g/n

2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a

4.9 – 4.95 GHz (Japan)

• 5.15 – 5.25 GHz

• 5.25 - 5.35 GHz

5.47 – 5.725 GHz

5.825 – 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Data Rates

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

Security1

 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

 Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models Roaming Output Power² Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)
IEEE 802.11 compliant roaming between access points

802.11b: +16dBm minimum 802.11g: +14dBm minimum 802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +12dBm minimum 802.11n HT40(5GHz): +12dBm minimum 802.11ac 80MHz(5GHz): +11dBm minimum

Power Consumption

Transmit: 2.0 W (max)
Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode



Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

> 802.11b, 11Mbps: -86dBm maximum 802.11q, 6Mbps: -88dBm maximum 802.11q, 54Mbps: -74dBm maximum 802.11a, 6Mbps : -86dBm maximum 802.11a, 54Mbps: -72dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 1SS, MCS-9: -61dBm maximum 802.11ac, 2SS, MCS-0: -83dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

PCI-Express M.2 MiniCard

Dimensions

Type 2230: 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230: 2.8g

Form Factor

0r

Type 1630: 2q

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)

LED Amber - Radio OFF: LED White - Radio ON

LED Activity

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification 4.0+EDR Compliant **Frequency Band** 2402 to 2480 MHz

79 (1 MHz) available channels **Number of Available Channels**

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of +4 dBm for BR and EDR.

Receiver Sensitivity

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm



Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Up to 33 ft (10 m)
Electrical Interface USB 2.0 compliant

Bluetooth Software Supported

re Supported Microsoft Windows Bluetooth Software

Link Topology Electrical Interface

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves **Bluetooth Software Supported** Full support of Bluetooth Security Provisions

Security

Power Management Microsoft Windows ACPI, and USB Bus Support

Power Management Self-configurable to optimize power conservation in all operating

Certifications modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Bluetooth Profiles Supported

Power ManagementETS 300 328, ETS 300 826CertificationsLow Voltage Directive IEC950

UL, CSA, and CE Mark Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,2

Generic Object Exchange Profile (GOEP)^{1,2}

Object Push Profile (OPP)^{1,2}
File Transfer Profile (FTP)

CertificationsSynchronization Profile (SYNC) **Bluetooth Profiles Supported**Hard Copy Cable Replacement (

orted Hard Copy Cable Replacement (HCRP)^{1,2}
Personal Area Networking Profile (PAN)^{1,2}
Human Interface Device Profile (HID)^{1,2}

FAX Profile (FAX)

Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Intel® 802.11 a/b/g/n (2X2) +Bluetooth®

 Wireless LAN
 IEEE 802.11a

 Standards
 IEEE 802.11b

 IEEE 802.11g
 IEEE 802.11n

Interoperability Wi-Fi certified **Frequency Band** 802.11b/g/n

• 2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable

those channels.



802.11a

4.9 – 4.95 GHz (Japan)

• 5.15 – 5.25 GHz

• 5.25 – 5.35 GHz

• 5.47 - 5.725 GHz

• 5.825 – 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Antenna Structure 2 transmit; 2 receive (2x2)

Data Rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

Security¹
• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g

mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX

Lite

WAPI

Sub-channels Multinational support with frequency bands and channels compliant to

local regulations.

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Output Power² • 802.11b: +16dBm minimum

• 802.11g: +14dBm minimum

• 802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum

802.11n HT40(2.4GHz): +13dBm minimum

802.11n HT20(5GHz): +12dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum



802.11a, 6Mbps: -86dBm maximum 802.11a, 54Mbps: -72dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n. MCS15: -66dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Or

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230: 2.8q

0r

Type 1630: 2q

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C) Non-operating

-40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-Non-operating

condensing)

5% to 95% (non-condensing) **Altitude** 0 to 10,000 ft (3,048 m) Operating

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED White - Radio ON Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification 4.0+EDR Compliant Frequency Band 2402 to 2480 MHz

Number of Available Channels 79 (1 MHz) available channels

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of +4 dBm for BR and EDR.

Receiver Sensitivity

Modulation 0.01% BER 0.001% BER **GFSK** -80 dBm -70 dBm π/4-DOPSK -70 dBm -80 dBm 8DPSK -80 dBm -70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Up to 33 ft (10 m)



Electrical Interface

Bluetooth Software Supported

Link Topology

Electrical Interface

Bluetooth Software Supported

Security

Power Management

Power Management

Certifications

Security Certifications

Certifications

Bluetooth Profiles Supported

Bluetooth Profiles Supported

Power Management Certifications

USB 2.0 compliant

Microsoft Windows Bluetooth Software

Point to Point, Multipoint Pico Nets up to 7 slaves Full support of Bluetooth Security Provisions

Microsoft Windows ACPI, and USB Bus Support

Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

All necessary regulatory approvals for supported countries, including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)^{1,2}

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)^{1,2}
File Transfer Profile (FTP)
Synchronization Profile (SYNC)

Hard Copy Cable Replacement (HCRP)^{1,2}

Personal Area Networking Profile (PAN)^{1,2} Human Interface Device Profile (HID)^{1,2}

FAX Profile (FAX)

Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Intel® 802.11 ac (2x2) WiFi + Bluetooth® 4.0 combo (Indonesia only)

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac Wi-Fi certified 802.11b/g/n

Interoperability Frequency Band

2.402 - 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a

4.9 – 4.95 GHz (Japan)



- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCSO ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi compliant (

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX
- WAPI

Network Architecture

Models Roaming Output Power² Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points 802.11b: +16dBm minimum

802.11g : +14dBm minimum 802.11a : +14dBm minimum

802.11n HT20(2.4GHz): +13dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +12dBm minimum 802.11n HT40(5GHz): +12dBm minimum 802.11ac 80MHz(5GHz): +11dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

Radio disabled: 30 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode 802.11b, 1Mbps: -94dBm maximum

Receiver Sensitivity³ 802.11b, 1

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -86dBm maximum 802.11a, 54Mbps: -72dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 1SS, MCS-9: -61dBm maximum



802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230: 2.8g

0r

Type 1630: 2q

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C) Operating 10% to 90% (non-condensing)

Humidity Non-operating 5% to 95% (non-condensing)

> Operating 0 to 10,000 ft (3,048 m)

> Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED White - Radio ON

4. Check latest software/driver release for updates on supported security features.

Maximum output power may vary by country according to local regulations.

6. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology

Bluetooth Specification 4.0+EDR Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available Channels 79 (1 MHz) available channels

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

0.001% BER

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric or 1306.9 kbps symmetric

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of +4 dBm for BR and EDR.

0.01% BER

GFSK -80 dBm -70 dBm π/4-DQPSK -80 dBm -70 dBm 8DPSK -80 dBm -70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Modulation

Selective Suspend 17 mW

Range Up to 33 ft (10 m) USB 2.0 compliant **Electrical Interface**

Bluetooth Software Supported

Microsoft Windows Bluetooth Software

Receiver Sensitivity

Link Topology

Electrical Interface

Bluetooth Software Supported

Security

Altitude

Point to Point, Multipoint Pico Nets up to 7 slaves

Full support of Bluetooth Security Provisions

Power Management Microsoft Windows ACPI, and USB Bus Support



HP EliteBook 850 G2 Notebook PC

Power Management Self-configurable to optimize power conservation in all operating

Certifications modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249 **Bluetooth Profiles Supported**

Power Management ETS 300 328, ETS 300 826 **Certifications** Low Voltage Directive IEC950

UL, CSA, and CE Mark Serial Port Profile (SPP)¹

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,2

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)^{1,2}
File Transfer Profile (FTP)

CertificationsSynchronization Profile (SYNC) **Bluetooth Profiles Supported**Hard Copy Cable Replacement (HCRP)^{1,2}

Personal Area Networking Profile (PAN)^{1,2} Human Interface Device Profile (HID)^{1,2}

FAX Profile (FAX)

Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Intel® Dual Band Wireless-AC 3160 802.11 ac (1x1) Wi-Fi + Bluetooth®

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
Wi-Fi certified

Interoperability Wi-Fi certified 802.11b/g/n

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- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
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- 802.11n HT40(2.4GHz): +13dBm minimum
- 802.11n HT20(5GHz): +12dBm minimum
- 802.11n HT40(5GHz): +12dBm minimum
- 802.11ac 80MHz(5GHz): +11dBm minimum

Power Consumption

Transmit: 2.0 W (max)
Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 60 mW (WLAN unassociated)

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802.11ac, 1SS, MCS-9: -61dBm maximum 802.11ac, 2SS, MCS-0: -83dBm maximum

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Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

7. Check latest software/driver release for updates on supported security features.

Maximum output power may vary by country according to local regulations.
 Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulations).

9. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).

AUDIO/MULTIMEDIA - DTS SOUND+

Hardware Implementation Realtek ALC3228 HD

Function Key Volume

Controls

Volume up, volume down, and mute

Full Duplex Yes

Microphone InStereoHeadphone/Line OutStereo

Integrated Microphone Yes, dual digital microphone array

Audio Output Quality Frequency Response 20 Hz – 20 kHz

Signal to Noise Ratio >85 dB
Total Harmonic 0.01%

Distortion

Noise Floor -110 dB



Play/Record Sampling

8 kHz – 48kHz

DAC ADC

Rate(s)

16, 20 or 24-bit 16 or 20-bit

Integrated Stereo Speakers Power Rating 2 Watts Impedance 4 Ohms

SECURITY

HP Fingerprint Reader

Mobile Voltage Operation 3.0V-3.6V

(optional)

Operating Temperature $14^{\circ} - 167^{\circ}F (-10^{\circ} - 75^{\circ}C)$

Current Consumption

36 mA peak

lmage

Low Latency Wait for

Finger

950 uA

Capture Rate

6000 lines/sec

ESD Resistance
Detection Matrix

IEC 61000-4-2 4B (±15KV)
200*1 (plus another secondary line)

508 dpi

12*3 mm sensor area

Smart Card Reader

Smart card standard

Dimensions (L × W × H)

PC/SC 2.0 for Windows smart card standard 0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm) ISO 7816 Class A and AB smart cards

Smart Card support
Smart Card Interface

Smart Card Interface with T = 0 and T = 1 support

Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via

external EEPROM

Operating systems

No driver is required for this device. Native support is provided by the

operating system.

Power

Normal Mode

With card present, before being suspended: 40.9 mA Without card present, before being suspended:

33.16 mA

After being suspended with smart card present: 380

μΑ

After being suspended without smart card present:

380 μΑ

Power Saving Mode With card present, before being suspended: 40.6 mA

Without card present: 380 µA

After being suspended with smart card present: 380

μΑ

Features

Support single slot

Support T0, T1 protocol



- Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436.
- SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM
- Support ISO7816 Class A, B and C (5V/3V/1.8V) card
- Implemented as an USB full speed device with bulk transfer endpoint, Mass
- Storage endpoint
- Built-in PLL for USB and Smart Card clocks requirement
- Support EEPROM for USB descriptors customization (PID/VID/ iManufacturer/iProduct/Serial Number), Direct Web Page Link, and accessing memory card module.
- EEPROM programmable via USB interface
- Support software update for memory card module
- Support Direct Web Page Link via configuration in external EEPROM
- Support short APDU and extended APDU
- Compatible with Microsoft USB-CCID driver
- Support remote wake up through inserting card/removing card
- Support USB selective suspend
- Support Power Saving Mode (Using one pin to select between Normal/PWR Saving Mode)
- Support card power over current protection mechanism
- Built in resonator.
- Support USB LPM (Link Power Management) features.
- Embedded clock source.

Power

HP 45W Smart AC Adapter Dimensions Non-Slim (740015)& Non-Input

Slim 2 Prong (742313)

95.0 x 40.0 x 26.5mm

90 to 265 VAC

Input Efficiency 88% min at 115 VAC / 89% min at 230VAC

Input frequency range 47 to 63 Hz

Input AC current 1.4 A at 90 VAC and maximum load

Output power 45W DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <8A, Over voltage protection- 29V max

automatic shutdown

Connector

Output

Environmental Design

3 pin/grounded, mates with interchangeable cords **Operating** 32° to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° to 121° F (-20° to 85° C)

temperature

Altitude 0 to 16,405 ft (0 to 5,000 m)

Humidity 0% to 95% **Storage Humidity** 0% to 95%



EMI and SafetyCertifications
CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals

- C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability - failure rate of less than 0.1% annually within

the first three years of operation.

HP 65W Smart AC Adapter **Dimensions** 4.17 x 1.85 x 1.1 in (10.6 x 4.7 x 2.8 cm)

 Weight
 0.62 lb (280 g)

 Input
 100 to 240 VAC

Input Efficiency 87% min at 115 VAC

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 VAC, 0.85 A at 180 VAC

Output Output power 65W

DC output 18.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector 3 pin/grounded, mates with interchangeable cords **Environmental Design** Operating temperature 32° to 104° F (0° to 40° C)

Non-operating (storage) -4° to 149° F (-20° to 65° C)

temperature

Altitude 0 to 16,405 ft (0 to 5, 000 m)

Humidity 20% to 80% Storage Humidity 10% to 90%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W EM Smart AC Adapter **Dimensions** 4.98 x 1.97 x 1.18 in (12.65 x 5.0 x 3.0 cm)

 Weight
 0.62 lb (300 g) max

 Input
 90 to 265 VAC

Input Efficiency 87% min at 115 VAC

Input frequency range 47 to 63 Hz
Input AC current 1.7 A at 90 VAC

Output Output power 65W

DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector 3 pin/grounded, mates with 4.5mm barrel type Smart ID DC connector

Environmental Design Operating 32° to 95° F (0° to 35° C)

temperature



Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,405 ft (0 to 5,000 m)

Humidity 20% to 95% Storage Humidity 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.

Primary Battery

3-cell HP Long Life (24WHr) Lithium-Ion Polymer **Dimensions** (H x W x L) 7.8 x 4.01 x 0.3 in(19.89x10.28x0.84 cm)

Weight 180 g

Cells/Type 3-cell Lithium-Ion Polymer

Energy Voltage 11.1

Amp-hour capacity 2.2 Ah Watt-hour capacity 24Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F(-10° to 50° C) Non-operating -4° to 140° F (-20° to 50° C)

Battery System in OFF or 3 hours

Re-Charge Time Standby Mode

Fuel Gauge LED No.

Warranty 1 year or 3 years*

*Battery warranty depends on the platform warranty.

Optional Travel Battery

Available

v N

3-cell HP Long Life (50 WHr) Lithium-Ion Polymer

Dimensions (H x W x L) 7.8 x 4.01 x 0.3 in(19.89x10.28x0.84 cm)

Weight 280 g

Cells/Type 3-cell Lithium-Ion Polymer

Energy Voltage 11.1

Amp-hour capacity 4.504Ah Watt-hour capacity 50Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F(-10° to 60° C)



QuickSpecs

HP EliteBook 850 G2 Notebook PC

Non-operating -4° to 140° F (-20° to 60° C)

Battery System in OFF or 3 hours

Re-Charge Time Standby Mode No

Warranty 1 year or 3 years*

*Battery warranty depends on the platform warranty.

Optional Travel Battery

Available

Fuel Gauge LED

ENVIRONMENTAL

TBD

Country of Origin

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
	HP Slim Ultrabook Messenger (up to 15.6" x .88"/22/5mm)	F3W14AA
Cases	HP Slim Ultrabook Top Load (up to 15.6" x .88"/22/5mm)	F3W15AA
Docking	HP 3001pr USB 3 Port Replicator	F3S42AA
	HP 3005pr USB 3.0 Port Replicator	H1L08AA#xxx
	HP 2013 UltraSlim Docking Station	D9Y32AA#xxx
	HP Universal Port Replicator	E6D70AA#xxx
	HP Display and Notebook Stand	AW662AA
Input/Output – Mice	HP Comfort Grip Wireless Mouse	H2L63AA
	HP X4000b Bluetooth Mouse	H3T50AA#xxx
	HP 3-Button USB Laser Mouse	H4B81AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Slim Bluetooth Mouse	F3J92AA#xxx
Input/Output – Keyboards	HP Stylish USB Keyboard and Mouse	H4B80AA#xxx
	HP Stylish Wireless Keyboard and Mouse	H4B79AA#xxx
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP 2.4 GHz Keyboard and Mouse	G1K29AA#xxx
Input/Output – Adapters	HP Wireless Display Adapter	J1V25AA#xxx
	USB Graphics Adapter Dual output	C5U89AA
	DisplayPort to VGA	F7W97AA
	DisplayPort to DVI Adapter	F7W96AA
_	DisplayPort to HDMI Cable	F3W43AA
Power	HP 65W Slim AC Adapter	H6Y82AA#xxx
	HP 90W Slim AC Adapter	H6Y83AA#xxx
	HP 90W Slim Combo AC Adapter w/USB	H6Y84AA#xxx
	HP 45W Smart AC Adapter	H6Y88AA#xxx
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP 90W Smart AC Adapter	H6Y90AA#xxx
	90W Smart AC/Auto/Air Combo Adapter	AJ652AA#xxx
Dattavias	90W Smart Auto/Truck Adapter	ED493AA
Batteries Security	HP CAO6XL Notebook Battery	E7U21AA
Security	HP Docking Station Cable Lock	AU656AA#XXX
Storage - External Storage	HP UltraSlim Keyed Cable Lock HP USB External DVDRW Drive	H4D73AA F2B56AA
Misc.	HP 15.6" Notebook PC Privacy Filter	J7H71AA
Misc. Displays	HP EliteDisplay S231d 23-in IPS LED BLU Notebook Docking	F3J72AA
νισμιαχο	Monitor	FJJ/ ZAM

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QuickSpecs

HP EliteBook 850 G2 Notebook PC

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